

Description

TSS Series are designed to protect baseband equipment such as modems, line cards, CPE and DSL equipments from damaging overvoltage transients. The series provide a robust peak surge current capability which enables equipments to comply with global regulatory standards.

Features

- Low voltage overshoot
- Low on-state voltage
- Does not degrade in capability after multiple surge events within limit.
- Low capacitance
- Fails short circuit when surged in excess of ratings
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD609A.01)
- IEC-61000-4-2ESD30KV(Air),30KV(Contact)

Mechanical Characteristics

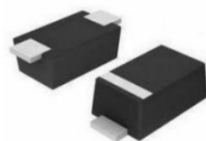
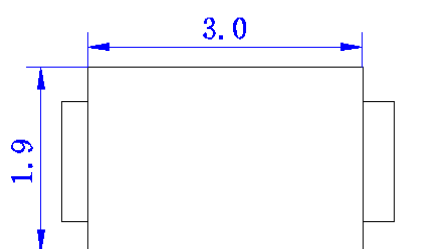
Package: SMF/SOD-123FL

- Case Material: "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Polarity: Color band denotes cathode except bi-directional models
- Weight: 0.017g
- Terminal Connections: See Diagram Below
- Marking Information: See Below

Applications

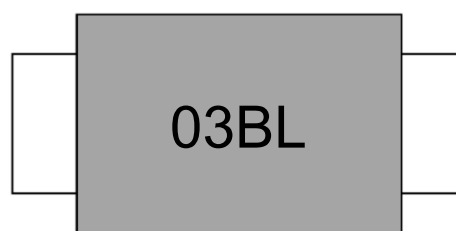
- Audio/Video line
- Network and telecom
- Data lines and security systems
- Serial ports

Dimensions & Symbol (Unit: mm Max)



Bi-directional

Marking Information



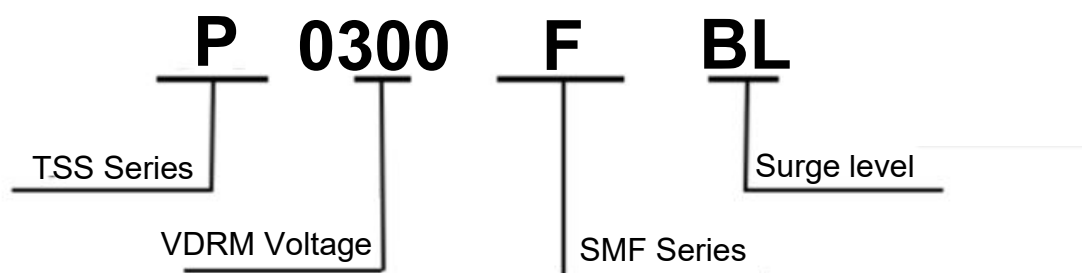
03BL: P0300FBL Marking code

Electrical Characteristics (T=25°C)

Part Number	$I_{DRM}@V_{DRM}$		$V_s @I_s$		$V_T@ I_T$		I_H	C_o
	μA	V	V	mA	V	A	mA	pF
	max	min	max	max	max	max	min	max
P0300FBL	5	25	40	800	4	2.2	20	60

Notes:

- All measurements are made at an ambient temperature of 25°C. I_{PP} applies to -40°C through +85°C temperature range.
- Off-state capacitance (C_o) is measured at 1 MHz with a 2 V bias and is typical val

Part number code

Absolute Maximum Ratings(T=25°C, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Operating junction temperature range	T_j	-40 to +125	°C
Storage temperature range	T_{stg}	-65 to +150	°C
Repetitive peak pulse voltage(10/700uS)	V_{PP}	3000	V
Repetitive peak pulse current(10/1000uS)	I_{PP}	35	A
Repetitive peak pulse current(8/20uS)	I_{PP}	220	A

Typical Characteristics

FIG1: V-I cure characteristics

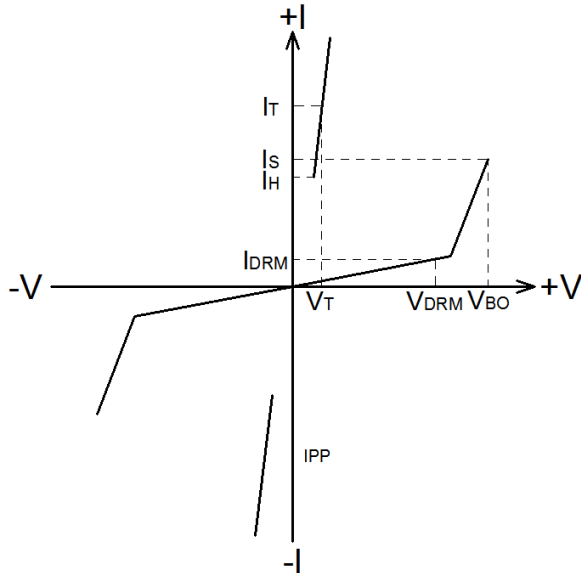


FIG2: Pulse Waveform

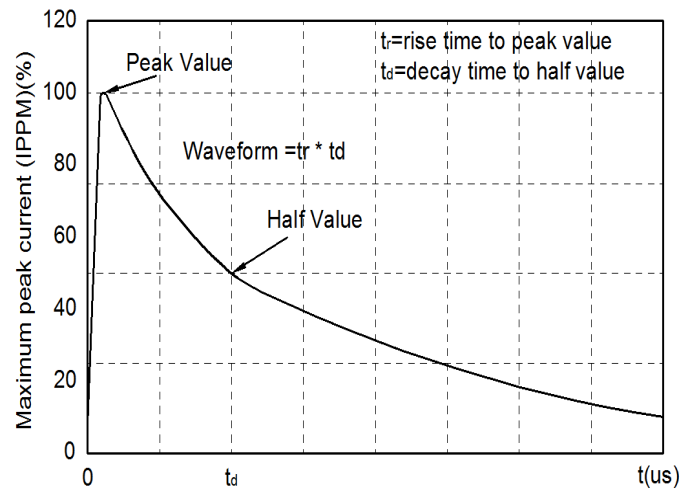


FIG3: Normalized V_s change vs.junction temperature

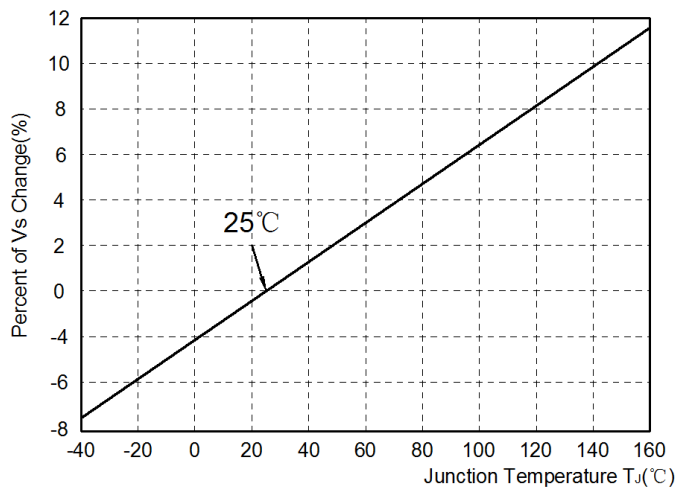
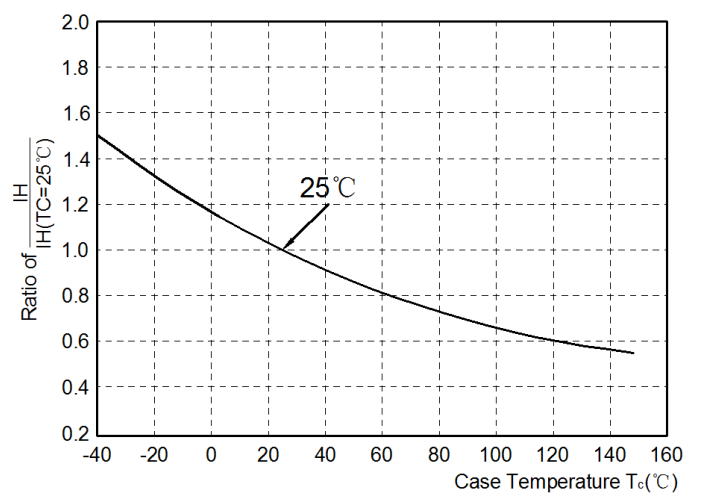
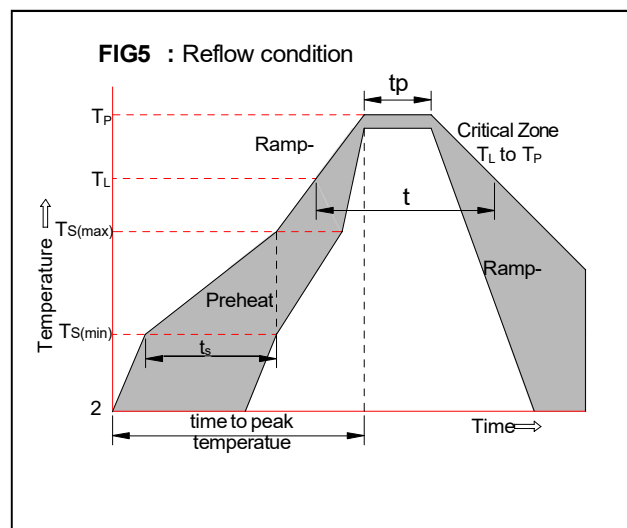


FIG4: Normalized DC holding current vs.case temperature



Reflow Condition		Pb-Free assembly (see as bellow)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_p)		8 min. Max
Do not exceed		+260°C

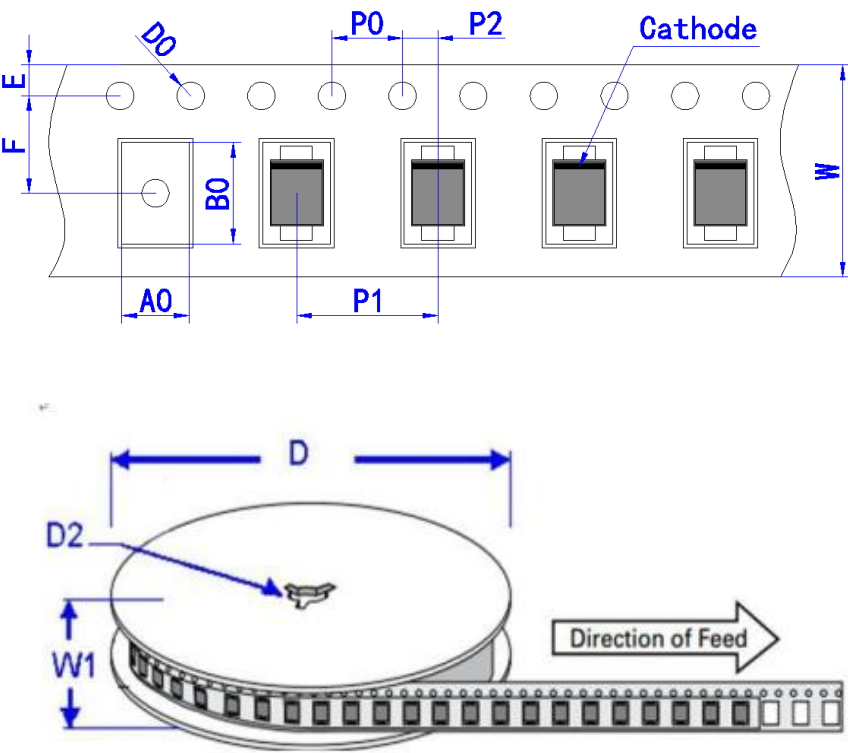


The image contains three technical drawings of mechanical parts with dimensions:

- Top Drawing:** A rectangular block with a central rectangular feature. Dimensions are labeled: A (top width), B (bottom width), C (left height), and D (right height).
- Middle Drawing:** A trapezoidal block with a central rectangular feature. Dimensions are labeled: F (left height), E (left width), and G (right height).
- Bottom Drawing:** Two rectangular blocks. The left block has dimensions 1.4 (height) and 1.3 (width). The right block has a width of 1.3 . The distance between the centers of the two blocks is 4.3 .

Ref.(mm)	Millimeters	
	Min.	Max.
A	2.5	3.0
B	3.4	4.0
C	0.7	1.1
D	1.5	1.9
E	0.45	0.95
F	0.05	0.26
G	0.9	1.1

Tape & reel specification - SOD-123FL



Ref.	Millimeters
A0	2.15±0.20
B0	3.95±0.20
C	178.00
D0	1.55±0.10
E	1.75±0.20
E1	13.50±1.00
F	3.50±0.10
P0	4.00±0.20
P1	4.00±0.20
P2	2.00±0.20
W	8.00±0.30
W1	9.00±4.00